

FIG. 1

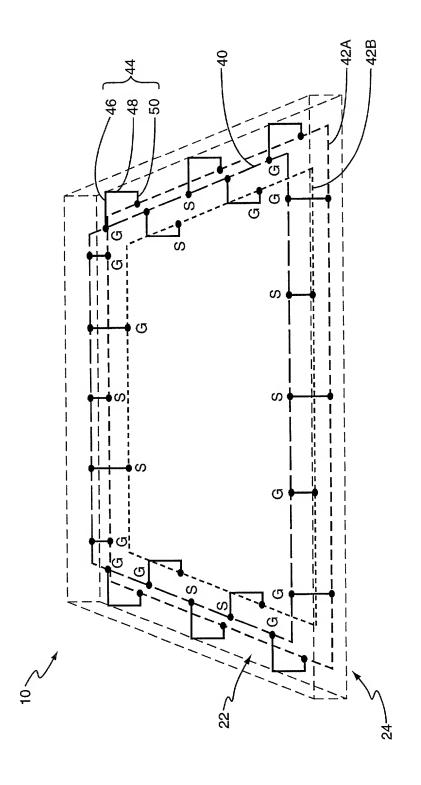


FIG. 2

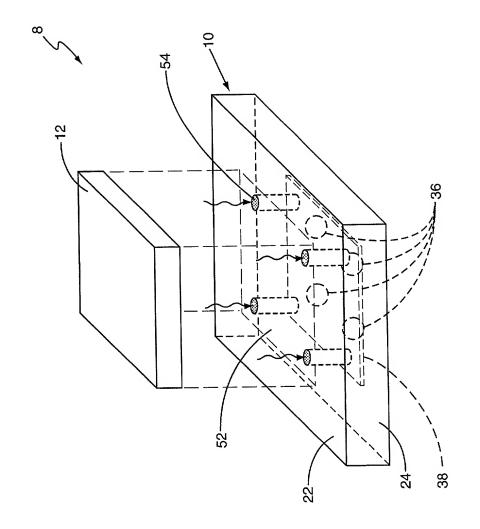


FIG. 3

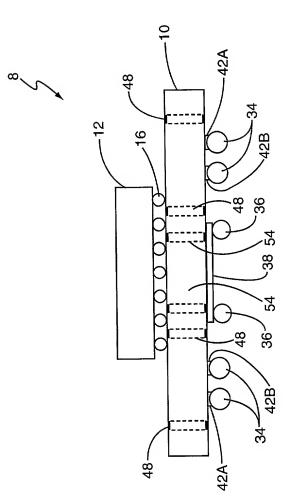


FIG. 4

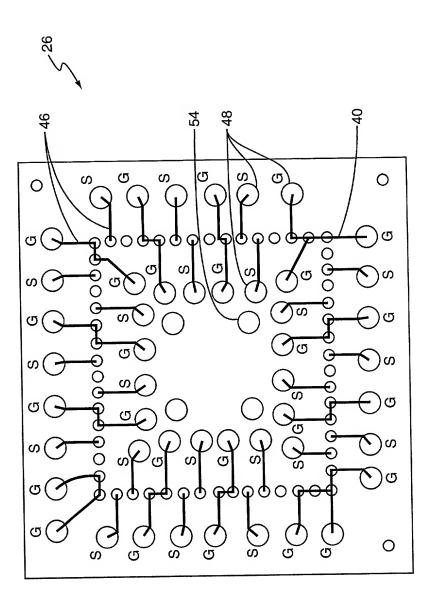


FIG. 5

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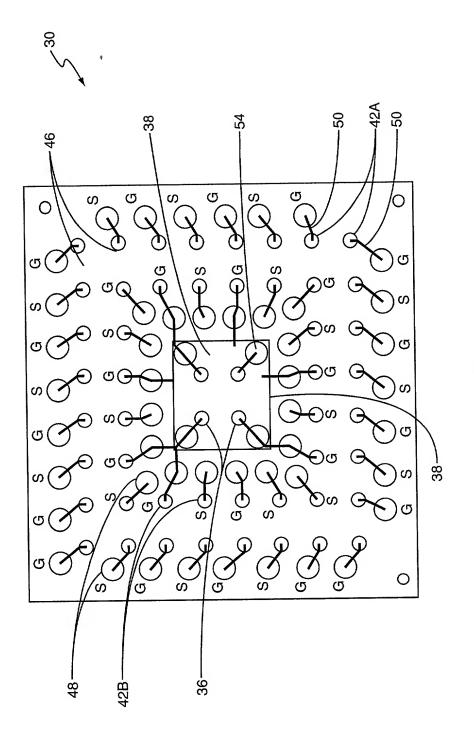


FIG. 6

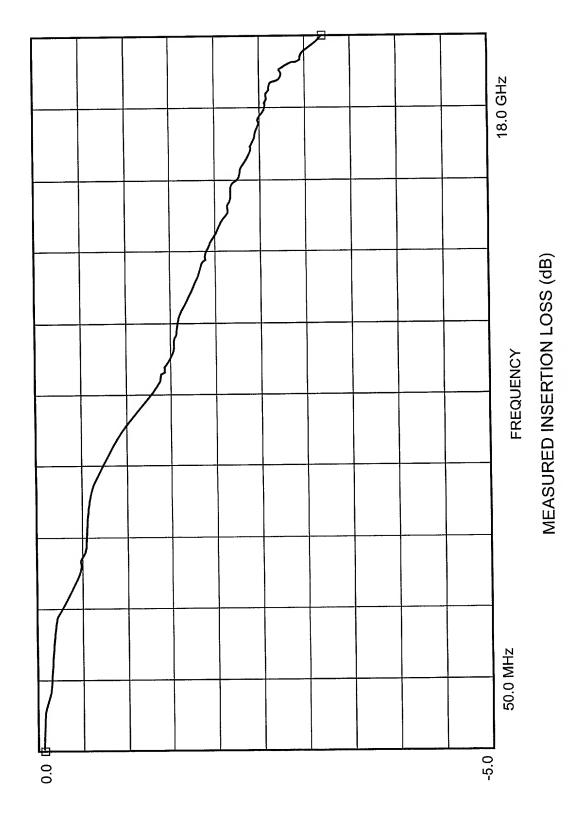
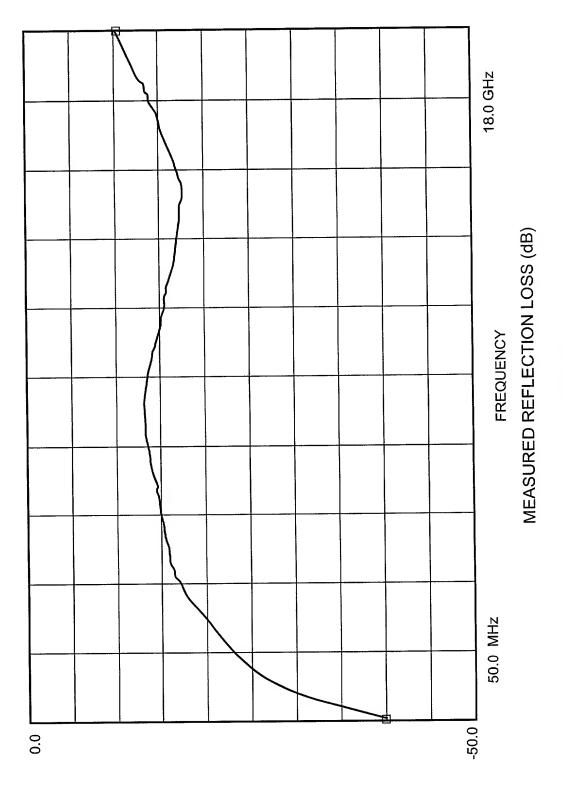


FIG. 7



F/G. 8

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EFFECT OF THERMAL BALLS, THERMAL VIAS AND GROUND PLANE ON THERMAL PERFORMANCE OF THE PACKAGE

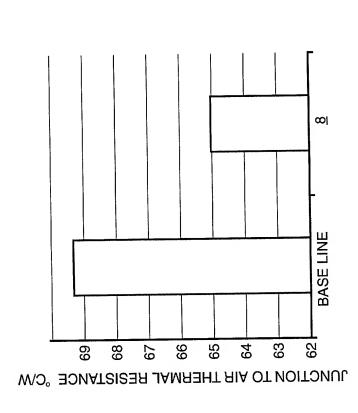


FIG. 9

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